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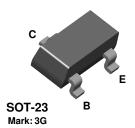
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MPSH11







NPN RF Transistor

This device is designed for common-emitter low noise amplifier and mixer applications with collector currents in the 100 $\mbox{$\mu$A}$ to 10 mA range to 300 MHz, and low frequency drift commonbase VHF oscillator applications with high output levels for driving FET mixers. Sourced from Process 47.

Absolute Maximum Ratings* TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	25	V
V _{CBO}	Collector-Base Voltage	30	V
V _{EBO}	Emitter-Base Voltage	3.0	V
I _C	Collector Current - Continuous	50	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max		Units	
		MPSH11	*MMBTH11		
P_D	Total Device Dissipation Derate above 25°C	350 2.8	225 1.8	mW mW/∘C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	1.0	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	556	°C/W	

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

¹⁾ These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

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TA = 25°C unless otherwise noted

Parameter	Test Conditions	Min	Max	Units
BACTERISTICS				
Collector-Emitter Sustaining Voltage*	$I_C = 1.0 \text{ mA}, I_B = 0$	25		V
Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	30		V
Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	3.0		V
Collector Cutoff Current	$V_{CB} = 25 \text{ V}, I_{E} = 0$		100	nA
Emitter Cutoff Current	$V_{EB} = 2.0 \text{ V}, I_{C} = 0$		100	nA
	RACTERISTICS Collector-Emitter Sustaining Voltage* Collector-Base Breakdown Voltage Emitter-Base Breakdown Voltage Collector Cutoff Current	RACTERISTICS Collector-Emitter Sustaining Voltage* $I_C = 1.0 \text{ mA}, I_B = 0$ Collector-Base Breakdown Voltage $I_C = 100 \mu\text{A}, I_E = 0$ Emitter-Base Breakdown Voltage $I_E = 10 \mu\text{A}, I_C = 0$ Collector Cutoff Current $V_{CB} = 25 \text{ V}, I_E = 0$	RACTERISTICS Collector-Emitter Sustaining Voltage* $I_C = 1.0 \text{ mA}, I_B = 0$ 25 Collector-Base Breakdown Voltage $I_C = 100 \mu\text{A}, I_E = 0$ 30 Emitter-Base Breakdown Voltage $I_E = 10 \mu\text{A}, I_C = 0$ 3.0 Collector Cutoff Current $V_{CB} = 25 \text{ V}, I_E = 0$	RACTERISTICS Collector-Emitter Sustaining Voltage* $I_C = 1.0 \text{ mA}, I_B = 0$ 25 Collector-Base Breakdown Voltage $I_C = 100 \mu\text{A}, I_E = 0$ 30 Emitter-Base Breakdown Voltage $I_E = 10 \mu\text{A}, I_C = 0$ 3.0 Collector Cutoff Current $V_{CB} = 25 \text{ V}, I_E = 0$ 100

ON CHARACTERISTICS

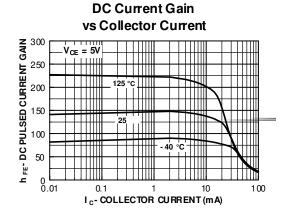
h _{FE}	DC Current Gain	$I_{C} = 4.0 \text{ mA}, V_{CE} = 10 \text{ V}$	60		
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 4.0 \text{ mA}, I_B = 0.4 \text{ mA}$		0.5	V
V _{BE(on)}	Base-Emitter On Voltage	$I_{C} = 4.0 \text{ mA}, V_{CE} = 10 \text{ V}$		0.95	V

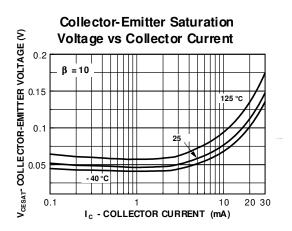
SMALL SIGNAL CHARACTERISTICS

f _T	Current Gain - Bandwidth Product	$I_C = 4.0 \text{ mA}, V_{CE} = 10 \text{ V},$ f = 100 MHz	650		MHz
C _{cb}	Collector-Base Capacitance	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1.0 \text{ MHz}$		0.7	pF
C _{rb}	Common-Base Feedback Capacitance	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1.0 \text{ MHz}$	0.6	0.9	pF
rb묬c	Collector Base Time Constant	$I_C = 4.0 \text{ mA}, V_{CB} = 10 \text{ V},$ f = 31.8 MHz		9.0	pS

^{*}Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

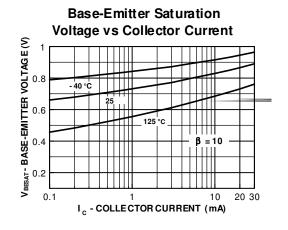
Typical Characteristics

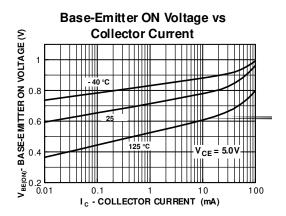




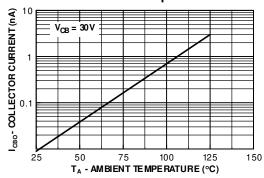
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Typical Characteristics (continued)

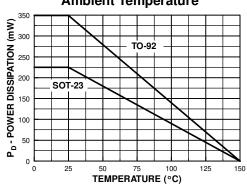




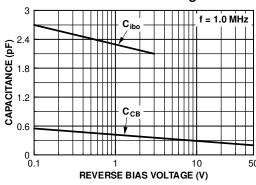
Collector Cut-Off Current vs Ambient Temperature



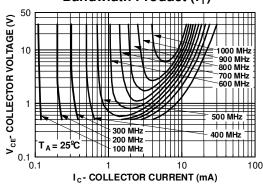
Power Dissipation vs Ambient Temperature



Capacitance vs Reverse Bias Voltage



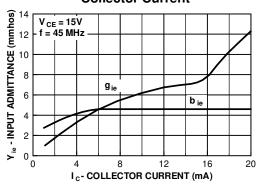
Contours of Constant Gain Bandwidth Product (f_T)



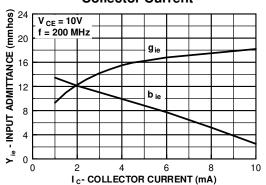
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Common Emitter Y Parameters

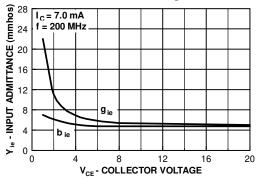
Input Admittance vs **Collector Current**



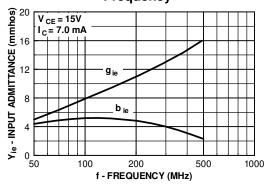
Input Admittance vs Collector Current



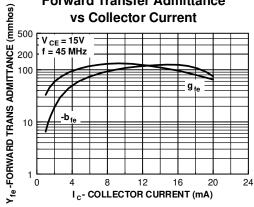
Input Admittance vs **Collector Voltage**



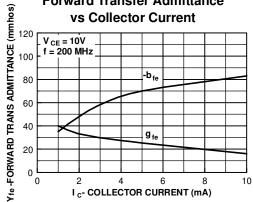
Input Admittance vs Frequency



Forward Transfer Admittance

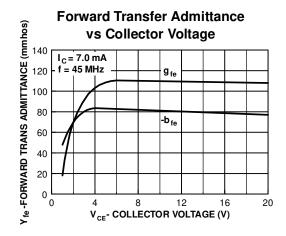


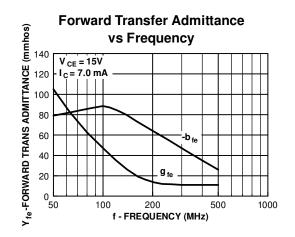
Forward Transfer Admittance

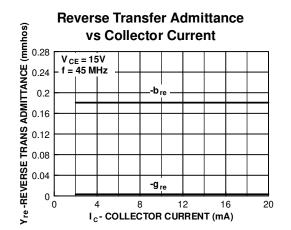


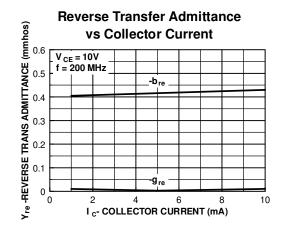
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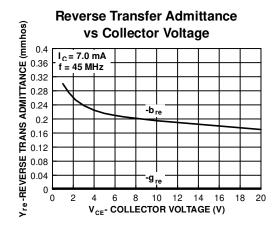
Common Emitter Y Parameters (continued)

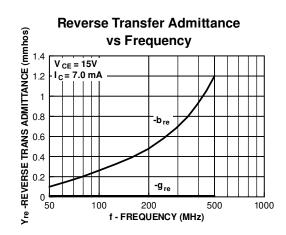








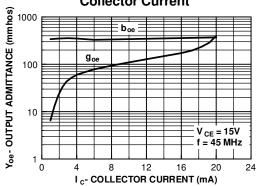




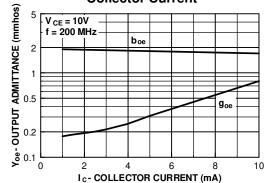
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Common Emitter Y Parameters (continued)

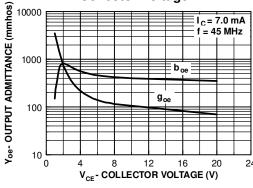




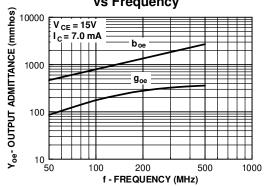
Output Admittance vs Collector Current



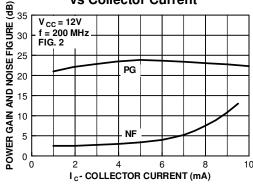
Output Admittance vs Collector Voltage



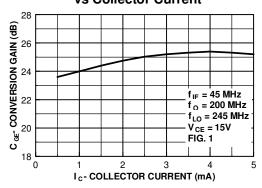
Output Admittance vs Frequency



Power Gain and Noise Figure vs Collector Current



Conversion Gain vs Collector Current



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Test Circuits

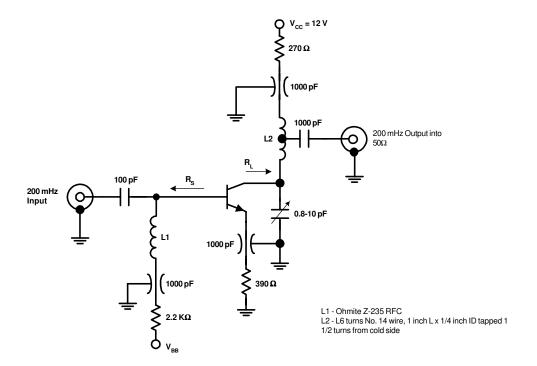


FIGURE 1: Unneutralized 200 MHz PG and NF Test Circuit

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Test Circuits (continued)

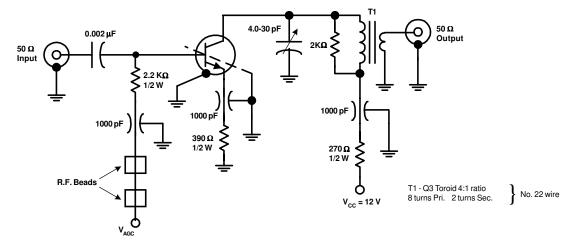


FIGURE 2: 45 MHz Power Gain Circuit

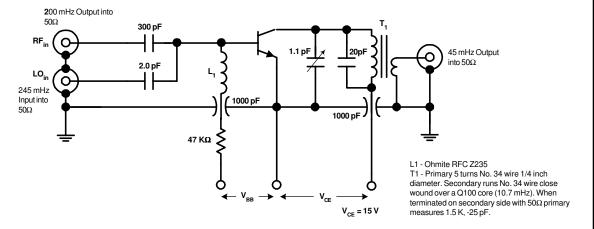


FIGURE 3: 200 MHz Conversion Gain Test Circuit

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